









PRODUCT DATASHEET



- ► EMC 2-PIN SMD
- ➤ 3014 0.52t
- ► Natural White 5000K

N0W64S23





3014 EMC Series





FEATURES:

Package: Top View EMC White Package

Forward Current: 30mA Forward Voltage (typ.): 9.5V

Luminous Flux (typ.): 38lm@30mA

Colour: Natural White

Colour Temperature (CCT): 5000K

Viewing angle: 120°

Materials:

Die: InGaN

Resin: Silicon (Yellow Diffused)

Package: EMC

Operating Temperature: -40~+105°C Storage Temperature: -40~+105°C **Electrostatics Discharge: 1000V**

Grouping parameters:

Forward Voltage

Luminous Flux

CIE Chromaticity

Soldering methods: Reflow Soldering

MSL Level: MSL3 according to J-STD020

Packing: 8mm tape with max.5000/reel, ø165mm (6.5")

APPLICATIONS:

- **General Lighting**
- Portable Lighting
- Commercial Lighting
- **Indoor Lighting**
- Backlight for LCD

Release Date: 31 January 2023 Version: A1.0



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C, RH=60%)

Parameter	Symbol	Ratings	Unit
DC Forward Current	I _F	40	mA
Pulse Forward Current (Duty 1/10, width≤100μS)	Ipf	60	mA
Power Dissipation	P _D	440	mW
Reverse Voltage	V _R	5	V
Reverse Current @10V	I _R	10	μΑ
Junction Temperature	Tj	125	°C
Electrostatic Discharge	ESD	1000	V
Thermal Resistance (Junction to Solder Point)	R _{тн} з	35	°C/W
Operating Temperature	T _{OPR}	-40~+105	°C
Storage Temperature	T _{STG}	-40~+105	°C
Soldering Temperature	T _{SOL}	230/260 for 10S	°C
Colour Rendering Index	CRI	80	

Electrical & Optical Characteristics (Ta=25°C, RH=60%)

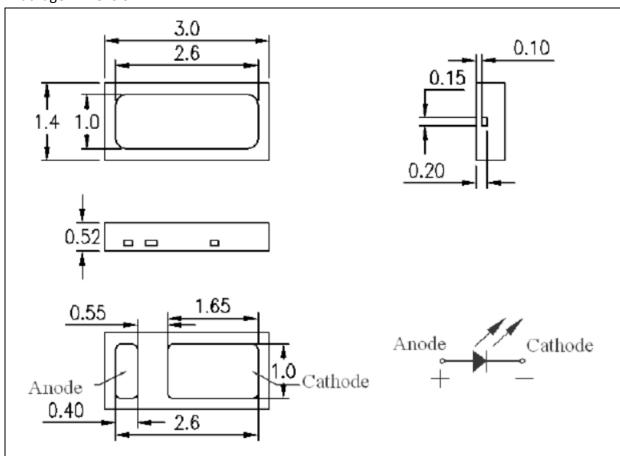
Parameter	Symbol	Values			Unit	Test	
Parameter	Зуппоп	Min.	Тур.	Max.	Offic	Condition	
Forward Voltage	V _F	8	9.5	11	V	I _F =30mA	
Luminous Flux	Ф۷	34	38	42	lm	I _F =30mA	
Chromaticity Coordinates	Х		0.3451			I _F =30mA	
	Υ		0.3554				
Colour Temperature	ССТ	4745	5028	5311	К	I _F =30mA	
Viewing Angle	2θ _{1/2}		120		deg	I _F =30mA	

^{1.} Luminous flux (Φ_V) ±10%, Forward Voltage (V_F) ±0.1V, CRI ±2



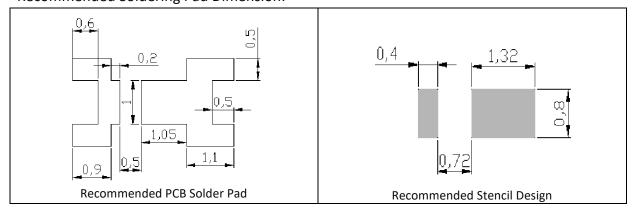
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 30mA):

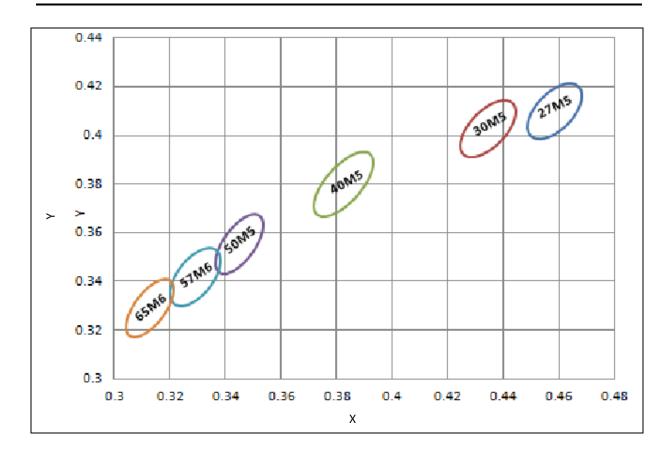
Code	Min.	Max.	Unit
1C	8	9	
1D	9	10	V
1E	10	11	

Luminous Flux Classifications (I_F = 30mA):

Code	Min.	Max.	Unit	
E1	34	36		
E2	36	38	lm	
E3	38	42		



CIE CHROMATICITY DIAGRAM:

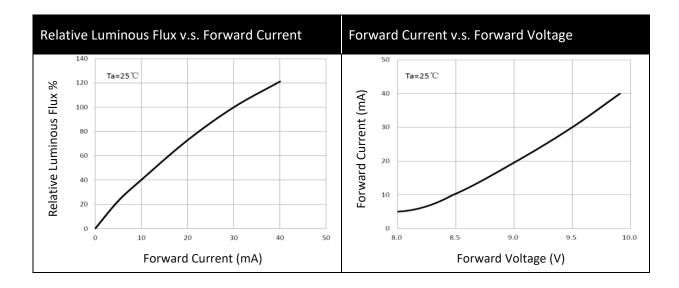


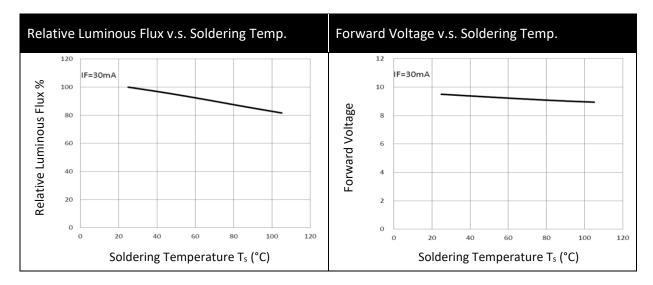
Chromaticity Coordinates Classifications (I_F = 30mA):

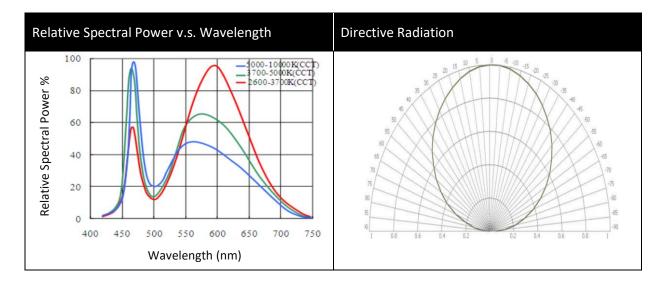
	Code	Centre		Radius		Angle
a /)		Х	Υ	а	b	Φ
D 0	50M5	0.3451	0.3554	0.013700	0.005900	59.37



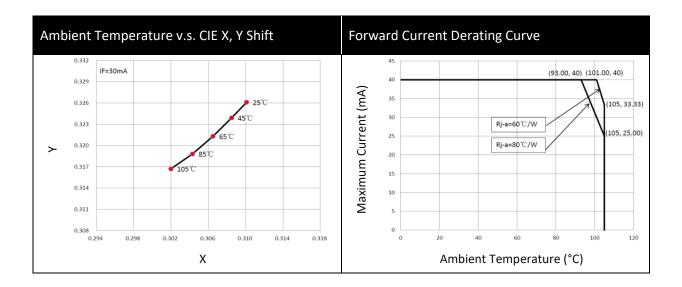
ELECTRO-OPTICAL CHARACTERISTICS:









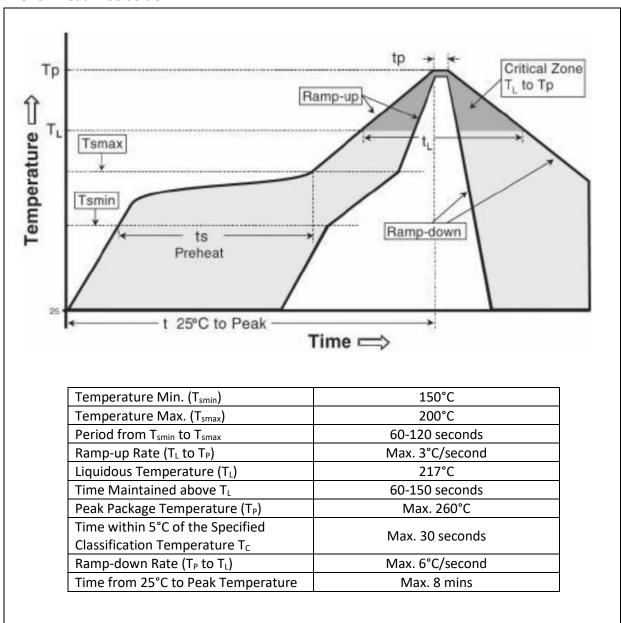


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RECOMMENDED SOLDERING PROFILE:

Reflow Lead-free Solder:



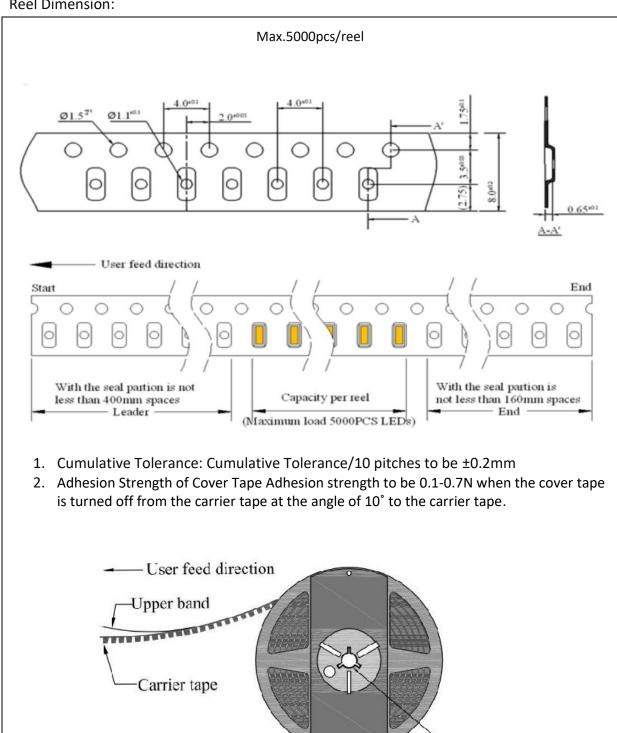
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended soldering temperature: 230°C. The maximum soldering temperature should be limited to 260°C for max. 10seconds.



PACKING SPECIFICATION:

Reel Dimension:



Ø165.1mm(6.5inch)

Ø13mm



PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

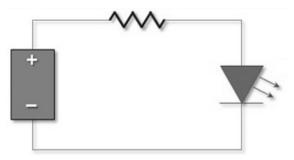
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	31/01/2023	Datasheet set-up.